

**Kingdom of Cambodia
Nation Religion King**



**Ministry of Education, Youth and Sport (MoYES)
Higher Education Improvement Project (HEIP)
IDA Credit No. 6221-KH**

**Request for Bids
Small Works
(One-Envelope Bidding Process)**

Country : Cambodia
Name of Project : Higher Education Improvement Project
Contract Title : Construction of Building
IDA Credit No. : 6221-KH
RFB Reference No. : MoEYS-HEIP-ICB-W-002

1. The Royal Government of Cambodia (RGC) has received financing from the International Development Association (IDA), World Bank toward the cost of the Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), IDA Credit No. 6221-KH and intends to apply part of the proceeds toward payments under the contract for the construction of Research Training Center Building and Master Plan at New Campus for ITC Ref.MoEYS-HEIP-ICB-W-002.
2. The Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS) now invites sealed Bids from eligible Bidders for Construction of New Campus for Institute of Technology of Cambodia, Location: in the Park of Garden City Development Project of LYP Group, Preak Taroth Village, Preak Tasek Commune, Chroy Changva District, Phnom Penh, Cambodia. Completion Period: **370 working days**. margin of preference: Not Applicable.
3. Bidding will be conducted through international competitive procurement using a Request for Bids (RFB) as specified in the World Bank's "Procurement Regulations for IPF Borrowers", dated July 1, 2016; revised in November 2017. ("Procurement Regulations"), and is open to all eligible Bidders as defined in the Procurement Regulations.
4. Interested eligible Bidders may obtain further information from Higher Education Improvement Project (HEIP), and inspect the bidding document at the address given below on **15 June 2022 to 02 August 2022 from 08:00 - 12:00 and 13:30 - 17:30 hours (Cambodia Time)**, Monday through Friday, except public holidays.
5. The bidding document in English may be obtained by interested Bidders upon the submission of a written application to the address below. The document is free of charge.
6. Bids must be delivered to the address below *on* or before **09:00 am on 03 August 2022**. **Electronic Bidding will not be permitted**. Late Bids will be rejected. Bids will be publicly

opened in the presence of the Bidders' designated representatives and anyone who chooses to attend at the address below at **09:00 am on 03 August 2022**.

7. All Bids must be accompanied by a **Bid-Securing Declaration**
8. Attention is drawn to the Procurement Regulations requiring the Borrower to disclose information on the successful bidder's beneficial ownership, as part of the Contract Award Notice, using the **Beneficial Ownership Disclosure Form** as included in the bidding document.
9. The address(es) referred to above is (are):
 - (i) Obtaining of information and collection of bidding document at:
procurement.dp@moeys.gov.kh and copy to chey.sith@moeys.gov.kh,
va.sith.pu@moeys.gov.kh and luon.monkol@moeys.gov.kh.
 - (ii) Submitting of bid document, and opening of bids:
Higher Education Improvement Project (HEIP), Ministry of Education Youth and Sport (MoEYS), Project Procurement Unit's meeting room of MoEYS, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia.

Attention: **Mr. Chey Sith**, Deputy Director General of Administration and Finance, MoEYS and Chief of Project Procurement Unit, HEIP, New Admin Building, 2nd Floor, Street 380, Sangkat Boeng Keng Kang I, Khan Boeng Keng Kang, Phnom Penh, Cambodia. Phone: (+855) 23 210 140, 23 726 757, Email: procurement.dp@moeys.gov.kh and copy to chey.sith@moeys.gov.kh, va.sith.pu@moeys.gov.kh and luon.monkol@moeys.gov.kh.